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Ullia Pale Pale Wolk Assucial Act of 1932 The	Application Number	10/788,700
TRANSMITTAL	Filing Date	February 27, 2004
FORM	First Named Inventor	Sidlgata V. Sreenivasan
(to be used for all correspondence after initial filing)	Art Unit	Unassigned
	Examiner Name	Unassigned
Total Number of Pages in This Submission	Attorney Docket Number	P107-49-03
	ENCLOSURES (Check all tha	nt apply)
Certified Copy of Priority Document(s) Response to Missing Parts/ Incomplete Application Response to Missing Parts under 37 CFR 1.52 or 1.53	Drawing(s) Licensing-related Papers Petition Petition to Convert to a Provisional Application Power of Attorney, Revocation Change of Correspondence Add Terminal Disclaimer Request for Refund CD, Number of CD(s) Remarks	Other Enclosure(s) (please Identify below): Form 1449 - IDS Forty-four (44) References Return Receipt Postcard to Kenneth Brooks
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No.: 10/788,700 Group Art Unit: Unassigned Filing Date: February 27, 2004 Examiner: Unassigned

For: FULL WAFER OR LARGE AREA IMPRINTING WITH MULTIPLE SEPARATED SUB-FIELDS FOR HIGH THROUGHPUT LITHOGRAPHY

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents Alexandria, VA 22313

Sir:

The following information is submitted in compliance with Applicants' duty of disclosure under 37 C.F.R. § 1.56. Form PTO-1449 and a copy of each reference recited below accompanies this document. It is respectfully requested that the cited information be expressly considered during the prosecution of this application, and the references be made of record therein and appear among the "references cited" on any patent to issue therefrom.

ISSUED PATENTS

Patent Number 4,724,222	Inventor Feldman	Grant Date 02/09/1988
4,731,155	Napoli et al.	03/15/1988
5,425,848	Haisma et al.	06/20/1995
5,669,303	Maracas et al.	09/23/1997
5,772,905	Chou	06/30/1998
5,900,160	Whitesides et al.	05/04/1999
5,948,470	Harrison et al.	09/07/1999
6,039,897	Lochhead et al.	03/21/2000
6,309,580	Chou	10/30/2001
6,334,960	Willson et al.	01/01/2002
6,518,168	Clem et al.	02/11/2003
6,696,220	Bailey et al.	02/24/2004

PENDING PATENT APPLICATIONS

Serial Number 09/698,317	<u>Inventor</u> Choi et al.	$\frac{\text{Filing Date}}{10/27/2000}$
10/136,188	Voisin	05/01/2002
10/194,414	Sreenivasan et al.	07/11/2002
10/194,991	Sreenivasan et al.	07/11/2002
10/293,224	Choi et al.	11/13/2002
10/293,919	Voisin	11/13/2002
10/316,963	Choi et al.	12/11/2002
10/614,716	Choi et al.	07/7/2003
10/735,110	Nimmakayala et al.	12/12/2003
10/780,821	Sreenivasan et al.	01/20/2004

PATENT APPLICATION PUBLICATIONS

Publication No.	Inventor	Publication Date
US 2002/0098426	Sreenivasan et al.	07-25-2002
US 2002/0094496	Choi et al.	07-18-2002
US 2003/0093122	Choi et al.	07-18-2002

FOREIGN PATENT DOCUMENTS

Document Number	Inventor	Pub. Date
DE 2800476	Lamprecht et al.	07/13/1978
JP 1-196749	Matsumoto et al.	08/08/1989
WO 01/69317	Montelius et al.	09/20/2001
WO 01/79592	Hallberg et al.	10/25/2001
WO 01/90816	Heidari	11/29/2001

NON-PATENT DOCUMENTS

Krug, Herbert et al. "Fine Patterning of Thin Sol-Gel Films,"
 Journal of Non-Crystalline Solids, 1992, 447-450.

Krauss, et al. "Fabrication of Nanodevices Using Sub-25nm Imprint Lithography," Appl. Phys. Lett., 67(21), 3114-3116, 1995.

- Chou et al. "Imprint of Sub-25 nm Vias and Trenches in Polymers," Applied Physics Letters, 67(21), pp. 3114-3116, 1995.
- Chou et al. "Imprint Lithography with 25-Nanometer Resolution," Science, vol. 272, Apr. 5, 1996, pp. 85-87.
- Haisma, J. et al. "Mold-Assisted Nanolithography: A Process for Reliable Pattern Replication," Journal of Vacuum Science and Technology, 1996, 14, 4124-4128.
- Chou et al. "Imprint Lithography with Sub-10 nm Feature Size and High Throughput", Microelectronic Engineering 35, 1997, 237-240.
- Feldman et al., "Wafer Chuck for Magnification Correction in X-ray Lithography," American Vacuum Society, 1998, pp. 3476-3479.
- Scheer, H.C. et al. "Problems of Nanoimprinting Technique for Nanometer Scale Pattern Definition," Journal of Vacuum Science and Technology, 1998, 16, 3917-3921.
- Colburn, M. et al. "Step and Flash Imprint Lithography: New Approach to High-Resolution Patterning," Proc. of SPIE, 1999, 3676, 379-389.
- Chou, Stephen et al. "Lithographically-induced Self Assembly of Periodic Micropillar Arrays," Journal of Vacuum Science and Technology, 1999, 17, 3197-3202.
- Ruchhoeft, P. et al. "Patterning Curved Surfaces: Template Generation by Ion Beam Proximity Lithography and Relief Transfer by Step and Flash Imprint Lithography," Journal of Vacuum Science and Technology, 1999, 17, 2965-2982.
- Choi, B.J. et al. "Design of Orientation Stages for Step and Flash Imprint Lithography," Precision Engineering, 2001, 25, 192-199.

Otto M. et al., "Step and Repeat UV-Nanoimprint Lithography: Material Issues," Nanoimprint and Nanoimprint Technology Conference, San Francisco, December 11-13, 2002.

Johnson et al., "Advances in Step and Flash Imprint Lithography," SPIE Microlithography Conference, February 23-28, 2003.

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Filing Date	02/27/2004	
First Named Inventor	Sreenivasan	
Group Art Unit	Unassigned	
Examiner Name	Unassigned	
Attorney Docket Number	P107/MII-72-54-03	

	1 1	U.S. Patent Do	ocument	U.S. PATENT DOCUMEN		Pages, Columns, Lines,
Examiner Initials*	Cite No. ¹	Number	Kind Code ² (if known)	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Where Relevant Passages or Relevant Figures Appear
	A1	4,724,222		Feldman	02-09-1988	
	A2	4,731,155		Napoli et al.	03-15-1988	
	A3	5,425,848		Haisma et al.	06-20-1995	
	A4	5,669,303		Maracas et al.	09-23-1997	
	A5	5,772,905		Chou	06-30-1998	
	A6	5,900,160		Whitesides et al.	05-04-1999	
	A7	5,948,470		Harrison et al.	09-07-1999	
	A8	6,039,897		Lochhead et al.	03-21-2000	
	A9	6,309,580		Chou	10-30-2001	
	A10	6,334,960		Willson et al.	01-01-2002	
	A11	6,518,168		Clem et al.	02-11-2003	
	A12	6,696,220		Bailey et al.	02-24-2004	· ·
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Application Number	10/788,700	
Filing Date	02/27/2004	
First Named Inventor	Sreenivasan	
Group Art Unit	Unassigned	
Examiner Name	Unassigned	
Attorney Docket Number	P107/MII-72-54-03	

	1	1	Foreign Patent Docum		PATENT DOCUMENTS		Pages, Columns, Lines,	т-
Examiner Initials*	Cite No. ¹	Office ³	Number ⁴	Kind Code ⁵ (if known)	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T ⁶
	A13	DE	2800476		Lamprecht et al.	07-13-1978		T
	A14	JP	1-196749		Matsumoto et al.	08-08-1989		Т
	A15	wo	01/69317		Montelius et al.	09-20-2001		\top
	A16	wo	01/79592		Hallberg et al.	10-25-2001		\top
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Application Number 10/788,700

Filing Date 02/27/2004

First Named Inventor Sreenivasan

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Sheet 3 of 5 Attorney Docket Number P107/MII-72-54-03

OTHER PRIC	R ART - I	NON PATENT LITERATURE DOCUMENTS	
Examiner Initials*	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
	A18	KRUG et al., "Fine Patterning of Thin Sol-Gel Films," Journal of Non-Crystalline Solids, 1992, pp. 447-450, vol. 147 & 148.	
	A19	Krauss et al., "Fabrication of Nanodevices Using Sub-25nm Imprint Lithography," Appl. Phys. Lett 67(21), 3114-3116, 1995	
, . ,	A20	CHOU et al., "Imprint of Sub-25 nm Vias and Trenches in Polymers," Applied Physics Letters, November 20, 1995, pp. 3114-3116, vol. 67(21).	
	A21	CHOU et al., "Imprint Lithography with 25-Nanometer Resolution," Science, Apr. 5, 1996, pp. 85-87, vol. 272.	
	A22	HAISMA et al., "Mold-Assisted Nanolithography: A Process for Reliable Pattern Replication," Journal of Vacuum Science and Technology, Nov/Dec 1996, pp. 4124-4128, vol. B 14(6).	
	A23	CHOU et al., "Imprint Lithography with Sub-10nm Feature Size and High Throughput," Microelectronic Engineering, 1997, pp. 237-240, vol. 35.	
	A24	FELDMAN et al., "Wafer chuck for manification correction in x-ray lithography," American Vacuum Society, 1998, pp. 3476-3479.	
	A25	SCHEER et al., "Problems of the Nanoimprinting Technique for Nanometer Scale Pattern Definition," Journal of Vacuum Science and Technology, Nov/Dec 1998, pp. 3917-3921, vol. B 16(6).	
	A26	COLBURN. et al., "Step and Flash Imprint Lithography: A New Approach to High-Resolution Patterning", Proc. of SPIE, 1999, pp. 379-389, vol. 3676.	
	A27	CHOU et al., "Lithographically-Induced Self Assembly of Periodic Polymer Micropillar Arrays," Journal of Vacuum Science and Technology, Nov/Dec 1999, pp. 3197-3202, vol. B 17(6).	
	A28	RUCHHOEFT et al., "Patterning Curved Surfaces: Template Generation by Ion Beam Proximity Lithography and Relief Transfer by Step and Flash Imprint Lithography," Journal of Vacuum Science and Technology, 1999, pp. 2965-2982, vol. 17.	

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-	A	29		•	•	es for Step and Flash Imprint Lithor Precision Engineering and Nanote	ography," Precision Engineering, echnology, 2001, pp. 192-199, vol.	
	A:	.30				Alignment and Gap Control Stage (698,317. Filed with USPTO on Oc		
	A:	.31			•	Overlay Alignment Methods and S 2/0098426. Published on July 25,		
	A	.32			• -	tomatic Fluid Dispensing for Imprin 94496. Published on July 18, 2002	- ' '	
	A	.33		ate fo	•	n Gap and Orientation Sensing Bell U.S. Patent Application Publication	, ,	
	A:	.34	•		ds of Manufacturing a L May 1, 2002.	ithography Template," U.S. Patent	Application 10/136,188, Filed	

Complete if Known

10/788,700

	A30	CHOI et al., "High Precision Orientation Alignment and Gap Control Stages for Imprint Lithography	
		Processes," U.S. Patent Application 09/698,317. Filed with USPTO on October 27, 2000.	
,	A31	SREENIVASAN et al., "High-Resolution Overlay Alignment Methods and Systems for Imprint Lithography," U.S. Patent Application Publication 2002/0098426. Published on July 25, 2002.	
	A32	CHOI et al., "Method and System of Automatic Fluid Dispensing for Imprint Lithography Processes," U.S. Patent Application Publication 2002/0094496. Published on July 18, 2002.	
	A33	CHOI et al., "Methods for High-Precision Gap and Orientation Sensing Between a Transparent Template and Substrate for Imprint Lithography," U.S. Patent Application Publication 2003/0093122. Published on July 18, 2002.	
	A34	VOISIN, "Methods of Manufacturing a Lithography Template," U.S. Patent Application 10/136,188, Filed with USPTO on May 1, 2002.	
	A35	SREENIVASAN et al., "Step and Repeat Imprint Lithography Systems," U.S. Patent Application 10/194,414. Filed with USPTO July 11, 2002.	
	A36	SREENIVASAN et al., "Step and Repeat Imprint Lithography Processes," U.S. Patent Application 10/194,991. Filed with USPTO July 11, 2002.	
<u>.</u>	A37	OTTO M. et al., "Step and Repeat UV-Nanoimprint Lithography: Material Issues," Nanoimprint and Nanoprint Technology Conference, San Francisco, December 11-13, 2002.	
	A38	JOHNSON, et al., "Advances in Step and Flash Imprint Lithography, " SPIE Microlithography Conference, February 23-28, 2003.	
	A39	CHOI et al., "A Chucking System and Method for Modulating Shapes of Subtrates," U.S. Patent Application 10/293,224. Filed with USPTO on November 13, 2002.	

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新	Application Number	10/788,700
FORMATION DISCLOSURE	Filing Date	02/27/2004
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		VOISIN, "Methods of Inspecting A Lithography Template," U.S. Patent Application 10/293,919. Filed with	
	A40	USPTO on November 13, 2002	
		CHOI et al., "A Method For Modulating Shapes of Substrates," U.S. Patent Application 10/316,963. Filed	
	A41	with USPTO on December 11, 2002.	
		CHOI et al., "A Conforming Template For Patterning Liquids Disposed On Substrates," U.S. Patent	1
	A42	Application 10/614,716. Filed with USPTO on July 7, 2003.	
		NIMMAKAYALA et al., "Magnification Correction Employing Out-of-Plane Distortion of a Substrate," U.S.	+
	A43	Patent Application 10/735,110. Filed with USPTO on December 12, 2003.	
	1	SREENIVASAN et al., "Method for Concurrently Employing Differing Materials to Form a Layer on a	+
	A44	Substrate," U.S. Patent Application 10/780,821. Filed with USPTO on January 20, 2004.	
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